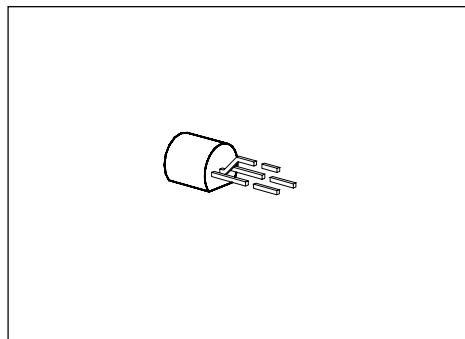


Silicon N Channel MOSFET Triode

BF 987

- For high-frequency stages up to 300 MHz, preferably in FM applications
- High overload capability



Type	Marking	Ordering Code	Pin Configuration			Package ¹⁾
			1	2	3	
BF 987	–	Q62702-F35	D	S	G	TO-92

Maximum Ratings

Parameter	Symbol	Values	Unit
Drain-source voltage	V_{DS}	20	V
Drain current	I_D	30	mA
Gate-source peak current	$\pm I_{GSM}$	10	
Total power dissipation, $T_A \leq 45 \text{ }^\circ\text{C}$	P_{tot}	300	mW
Storage temperature range	T_{stg}	– 55 ... + 150	$^\circ\text{C}$
Channel temperature	T_{ch}	150	

Thermal Resistance

Junction - ambient	$R_{th JA}$	≤ 350	K/W
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¹⁾ For detailed information see chapter Package Outlines.

Electrical Characteristicsat $T_A = 25\text{ }^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

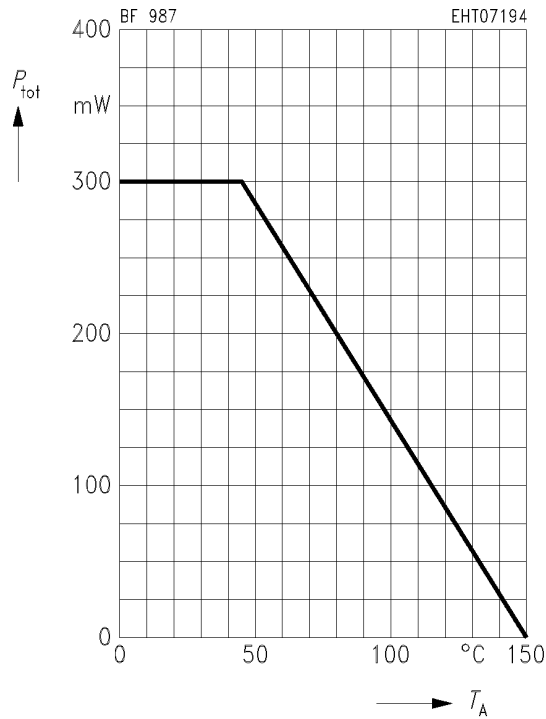
DC Characteristics

Drain-source breakdown voltage $I_D = 10\text{ }\mu\text{A}$, $-V_{GS} = 4\text{ V}$	$V_{(BR)DS}$	20	–	–	V
Gate-source breakdown voltage $\pm I_{GS} = 10\text{ mA}$, $V_{DS} = 0$	$\pm V_{(BR)GSS}$	6.5	–	12	
Gate-source leakage current $\pm V_{GS} = 5\text{ V}$, $V_{DS} = 0$	$\pm I_{GSS}$	–	–	50	nA
Drain current $V_{DS} = 10\text{ V}$, $V_{GS} = 0$	I_{DSS}	5	–	18	mA
Gate-source pinch-off voltage $V_{DS} = 10\text{ V}$, $I_D = 20\text{ }\mu\text{A}$	$-V_{GS(p)}$	–	–	2.5	V

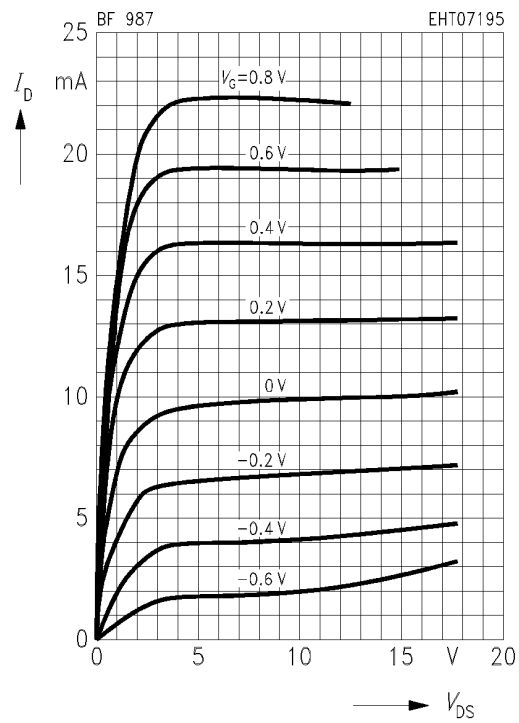
AC Characteristics

Forward transconductance $V_{DS} = 10\text{ V}$, $I_D = 10\text{ mA}$, $f = 1\text{ kHz}$	g_{fs}	14	16	–	mS
Gate input capacitance $V_{DS} = 10\text{ V}$, $I_D = 10\text{ mA}$, $f = 1\text{ MHz}$	C_{gss}	–	2.7	–	pF
Reverse transfer capacitance $V_{DS} = 10\text{ V}$, $I_D = 10\text{ mA}$, $f = 1\text{ MHz}$	C_{dg}	–	35	–	fF
Output capacitance $V_{DS} = 10\text{ V}$, $I_D = 10\text{ mA}$, $f = 1\text{ MHz}$	C_{dss}	–	1	–	pF
Power gain (test circuit) $V_{DS} = 10\text{ V}$, $I_D = 10\text{ mA}$, $f = 200\text{ MHz}$, $G_G = 2\text{ mS}$, $G_L = 0.5\text{ mS}$	G_p	–	25	–	dB
Noise figure (test circuit) $V_{DS} = 10\text{ V}$, $I_D = 10\text{ mA}$, $f = 200\text{ MHz}$, $G_G = 2\text{ mS}$, $G_L = 0.5\text{ mS}$	F	–	1	–	

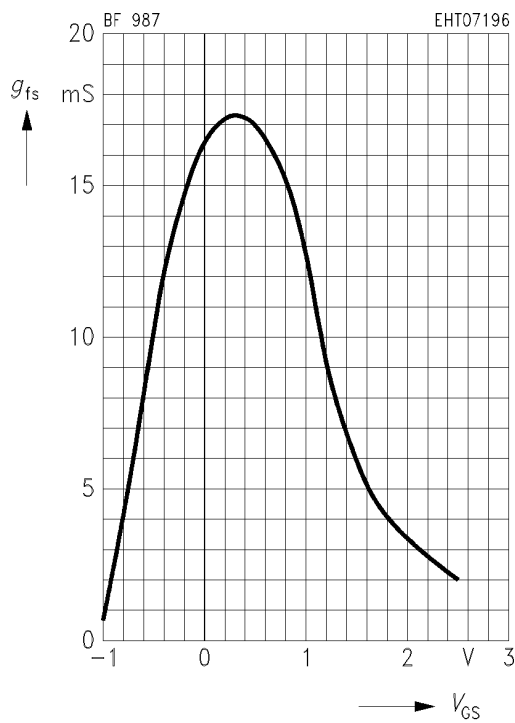
Total power dissipation $P_{tot} = f(T_A)$



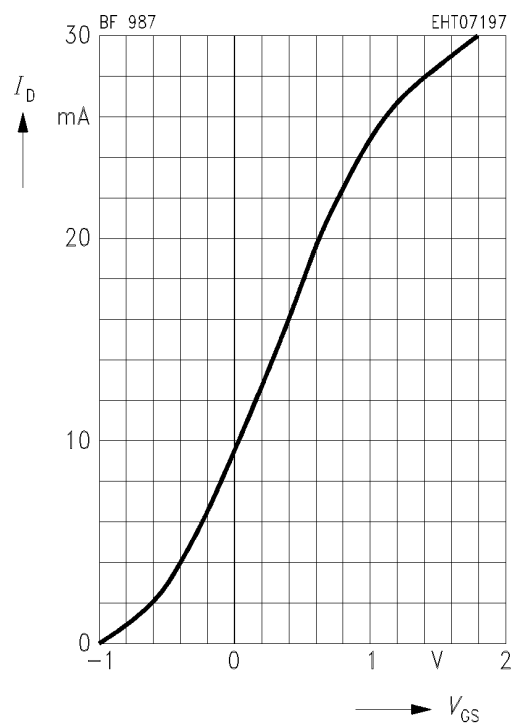
Output characteristics $I_D = f(V_{DS})$



Gate transconductance $g_{fs} = f(V_{GS})$
 $V_{DS} = 10 \text{ V}$, $I_{DSS} = 10 \text{ mA}$, $f = 1 \text{ kHz}$

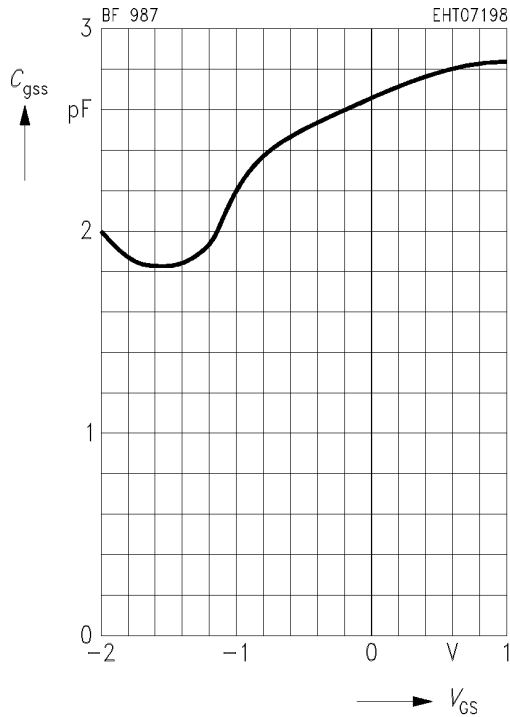


Drain current $I_D = f(V_{GS})$
 $V_{DS} = 10 \text{ V}$



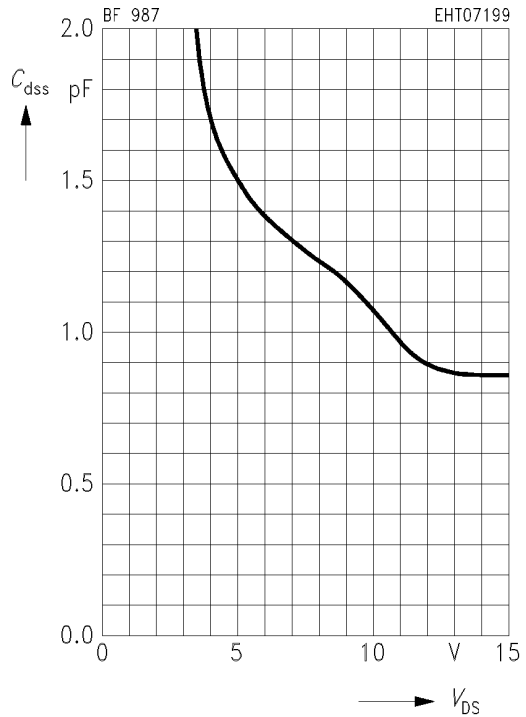
Gate input capacitance $C_{gss} = f(V_{GS})$

$V_{DS} = 10\text{ V}$, $I_{DSS} = 10\text{ mA}$, $f = 1\text{ MHz}$



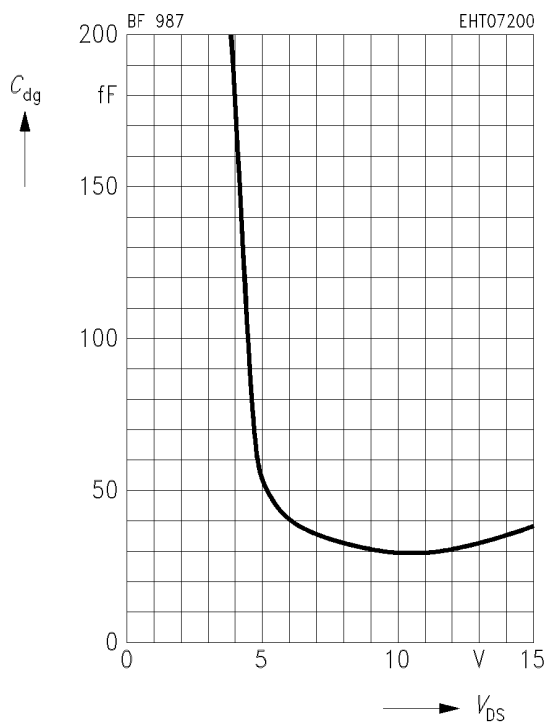
Output capacitance $C_{dss} = f(V_{DS})$

$V_{GS} = 0$, $I_{DSS} = 10\text{ mA}$, $f = 1\text{ MHz}$



Reverse transfer capacitance $C_{dg} = f(V_{DS})$

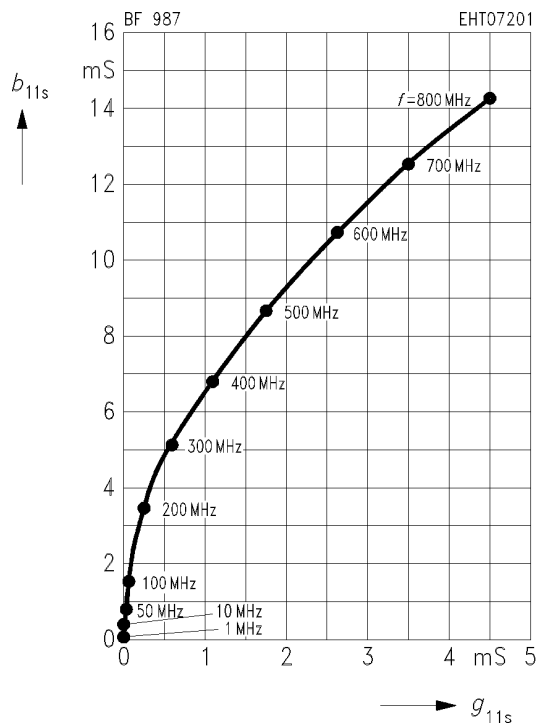
$I_{DSS} = 10\text{ mA}$, $f = 1\text{ MHz}$, $V_{GS} = 0$



Gate input admittance y_{11s}

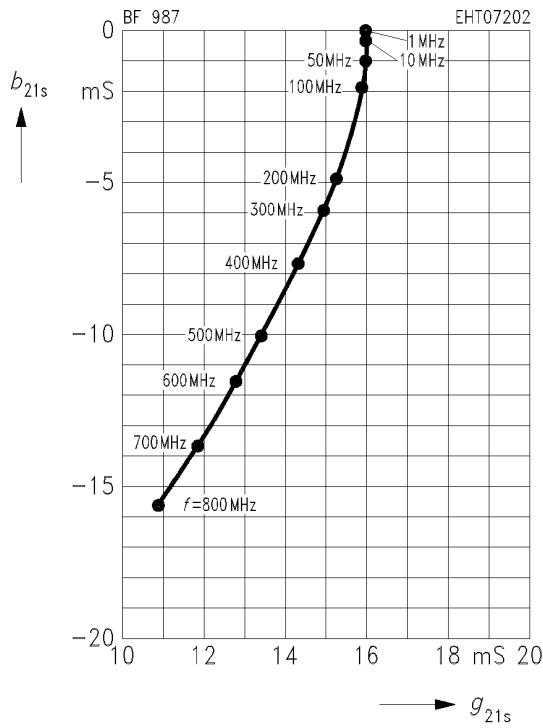
$V_{DS} = 10\text{ V}$, $I_{DSS} = 10\text{ mA}$, $V_G = 0$

(common source)



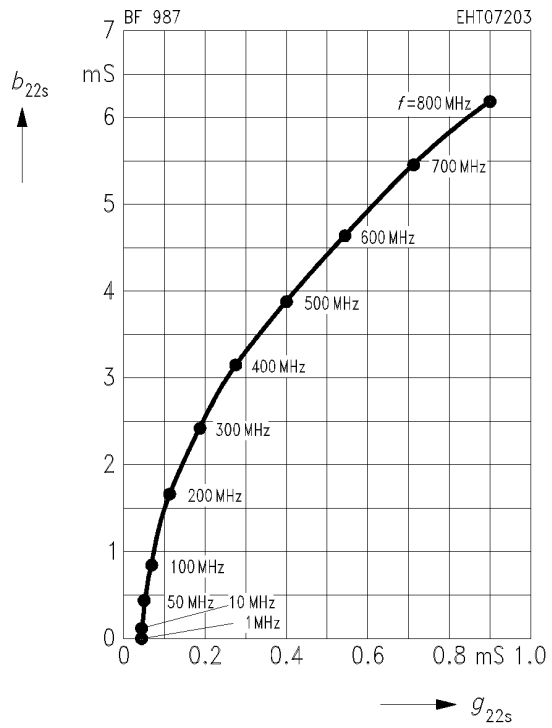
Gate forward transfer admittance y_{21s}

$V_{DS} = 10\text{ V}$, $V_G = 0$, $I_{DSS} = 10\text{ mA}$
(common source)



Output admittance y_{22s}

$V_{DS} = 10\text{ V}$, $I_{DSS} = 10\text{ mA}$, $V_G = 0$
(common source)



Test circuit for power gain and noise figure
 $f = 200\text{ MHz}$

